

RDA5807M

SINGLE-CHIP BROADCAST FM RADIO TUNER

Rev.1.0-May.2011

1 General Description

The RDA5807M series is the newest generation single-chip broadcast FM stereo radio tuner with fully integrated synthesizer, IF selectivity, RDS/RBDS and MPX decoder. The tuner uses the CMOS process, support multi-interface and require the least external component. All these make it very suitable for portable devices.

The RDA5807M series has a powerful low-IF digital audio processor, this make it have optimum sound quality with varying reception conditions.

The RDA5807M series support frequency range is from 50MHz to 115MHz.

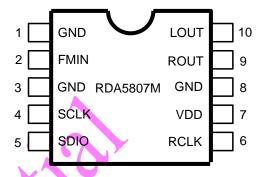


Figure 1-1. RDA 5807M Top View

1.1 Features

- CMOS single-chip fully-integrated FM tuner
- Low power consumption
 - Total current consumption lower than 20mA at 3.0V power supply when under normal situation
- Support worldwide frequency band
 - > 50 -115 MHz
- Support flexible channel spacing mode
 - > 100KHz, 200KHz, 50KHz and 25KHz
- Support RDS/RBDS
- Digital low-IF tuner
 - Image-reject down-converter
 - High performance A/D converter
 - > IF selectivity performed internally
- Fully integrated digital frequency synthesizer
 - Fully integrated on-chip RF and IF VCO
 - > Fully integrated on-chip loop filter
- Autonomous search tuning
- Support 32.768KHz crystal oscillator
- Digital auto gain control (AGC)
- Digital adaptive noise cancellation

- Mono/stereo switch
- Soft mute
- ➤ High cut
- Programmable de-emphasis (50/75 μs)
- Receive signal strength indicator (RSSI) and SNR
- Bass boost
- Volume control and mute
- Line-level analog output voltage
- 32.768 KHz 12M,24M,13M,26M,19.2M,38.4MHz
 Reference clock
- Only support 2-wire bus interface
- Directly support 32Ω resistance loading
- Integrated LDO regulator
 - > 1.8 to 3.3 V operation voltage
- MSOP—10pins

1.2 Applications

- Cellular handsets
- MP3, MP4 players
- Portable radios

PDAs, Notebook



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2 Functional Description

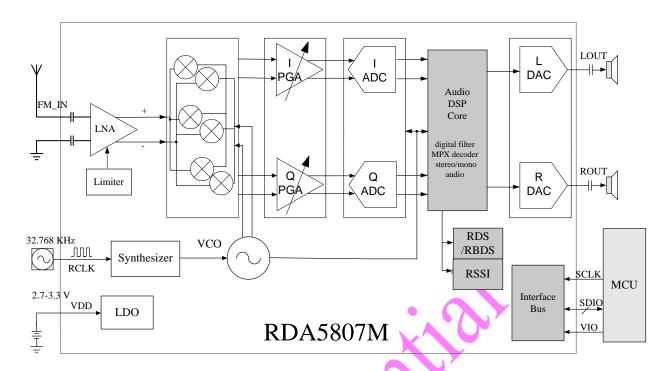


Figure 2-1. RDA5807M FM Tuner Block Diagram

2.1 FM Receiver

The receiver uses a digital low-IF architecture that avoids the difficulties associated with direct conversion while delivering lower solution cost and reduces complexity, and integrates a low noise amplifier (LNA) supporting the FM broadcast band (50 to 115MHz), a multi-phase image-reject mixer array, a programmable gain control (PGA), a high resolution analog-to-digital converters (ADCs), an audio DSP and a high-fidelity digital-to-analog converters (DACs).

The limiter prevents overloading and limits the amount of intermodulation products created by strong adjacent channels.

The multi-phase mixer array down converts the LNA output differential RF signal to low-IF, it also has image-reject function and harmonic tones rejection.

The PGA amplifies the mixer output IF signal and then digitized with ADCs.

The DSP core finishes the channel selection, FM demodulation, stereo MPX decoder and output audio signal. The MPX decoder can autonomous switch from stereo to mono to limit the output

noise.

The DACs convert digital audio signal to analog and change the volume at same time. The DACs has low-pass feature and -3dB frequency is about 30 KHz.

2.2 Synthesizer

The frequency synthesizer generates the local oscillator signal which divide to multi-phase, then be used to downconvert the RF input to a constant low intermediate frequency (IF). The synthesizer reference clock is 32.768 KHz.

The synthesizer frequency is defined by bits CHAN[9:0] with the range from 50MHz to 115MHz.

2.3 Power Supply

The RDA5807M integrated one LDO which supplies power to the chip. The external supply voltage range is 1.8-3.3 V.

2.4 RESET and Control Interface select

The RDA5807M is RESET itself When VIO is Power up. And also support soft reset by trigger 02H BIT1 from 0 to 1. The RDA5807M only support I²C control interface bus mode.

2.5 Control Interface

The RDA5807M only supports I²C control interface.

The I²C interface is compliant to I²C Bus Specification 2.1. It includes two pins: SCLK and SDIO. A I²C interface transfer begins with START condition, a command byte and data bytes, each byte has a followed ACK (or NACK) bit, and ends with STOP condition. The command byte includes a 7-bit chip address (0010000b) and a R/W bit. The ACK (or NACK) is always sent out by receiver. When in write transfer, data bytes is written out

from MCU, and when in read transfer, data bytes is read out from RDA5807M. There is no visible register address in I²C interface transfers. The I²C interface has a fixed start register address (0x02h for write transfer and 0x0Ah for read transfer), and an internal incremental address counter. If register address meets the end of register file, 0x3Ah, register address will wrap back to 0x00h. For write transfer, MCU programs registers from register 0x02h high byte, then register 0x02h low byte. then register 0x03h high byte, till the last register. RDA5807M always gives out ACK after every byte, and MCU gives out STOP condition when register programming is finished. For read transfer, after command byte from MCU, RDA5807M sends out register 0x0Ah high byte, then register 0x0Ah low byte, then register 0x0Bh high byte, till receives NACK from MCU. MCU gives out ACK for data bytes besides last data byte. MCU gives out NACK for last data byte, and then RDA5807M will return the bus to MCU, and MCU will give out STOP condition.

3 Electrical Characteristics

Table 3-1 DC Electrical Specification (Recommended Operation Conditions):

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT
VDD	Supply Voltage	1.8	3.0	3.3	V
T _{amb}	Ambient Temperature	-20	27	+75	$^{\circ}$
V _{IL}	CMOS Low Level Input Voltage	0		0.3*VIO	V
V _{IH}	CMOS High Level Input Voltage	0.7*VIO		VIO	V
V _{TH}	CMOS Threshold Voltage		0.5*VIO		V

Table 3-2 DC Electrical Specification (Absolute Maximum Ratings):

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT
VIO	Interface Supply Voltage	-0.5		+3.3	V
T _{amb}	Ambient Temperature	-40		+90	°C
I _{IN}	Input Current (1)	-10		+10	mA
V _{IN}	Input Voltage ⁽¹⁾	-0.3		VIO+0.3	V
V _{Ina}	LNA FM Input Level			+10	dBm

Notes:

1. For Pin: SCLK, SDIO

Table 3-3 Power Consumption Specification

(VDD = 3 V, $T_A = 25^{\circ}C$, unless otherwise specified)

SYMBOL	DESCRIPTION	CONDITION	TYP	UNIT
I _{VDD}	Supply Current ⁽¹⁾	ENABLE=1	20	mA
I _{VDD}	Supply Current ⁽²⁾	ENABLE=1	21	mA
I _{VIO}	Interface Supply Current	SCLK and RCLK active	60	μΑ
I _{PD}	Powerdown Current	ENABLE=0	5	μΑ
I _{VIO}	Interface Powerdown Current	ENABLE=0	10	μΑ

Notes:

1. For strong input signal condition

2. For weak input signal condition

Receiver Characteristics 4

Receiver Characteristics Table 4-1

(VDD = 3 V, T_A = 25 °C, unless otherwise specified)

SYMBOL	PARAMETER	CONDI	TIONS	MIN	TYP	MAX	UNIT
General spe	cifications			1			1
F _{in}	FM Input Frequency Range	Adjust BAN	ID Register	50		115	MHz
			50MHz	-	1.4	1.8	
			65MHz	-	1.2	1.5	
	Sensitivity ^{1,2,3}	S/N=26dB	88MHz	-	1.2	1.5	
V_{rf}	Sensitivity	3/N=200D	98MHz	-	1.3	1.5	μV EMF
			108MHz	-	1.3	1.5	
			115MHz	-	1.3	1.8	
IP3 _{in}	Input IP3 ⁴	AGC	D=1	80	-	-	dΒμV
α_{am}	AM Suppression ^{1,2}	m=	0.3	60		-	dB
S ₂₀₀	Adjacent Channel Selectivity	±200	OKHz	50	70	-	dB
S ₄₀₀	400KHz Selectivity	±400)KHz	60	85	-	dB
V _{AFL} ; V _{AFR}	Audio L/R Output Voltage ^{1,2} (Pins LOUT and ROUT)	Volume [3	3:0] =1111) ·	360	-	mV
0/1	Maximum Signal to Noise		Mono ²	55	57	-	in.
S/N	Ratio 1,2,3,5		Stereo ⁶	53	55	-	- dB
α_{SCS}	Stereo Channel Separation	CAL	J.	35	-	-	dB
R _L	Audio Output Loading Resistance	Single-	-ended	32	-	-	Ω
TUD	Audio Total Harmonic	Volume[3:0]	R _{load} =1KΩ	-	0.15	0.2	0/
THD	Distortion ^{1,3,6}	=1111	R _{load} =32Ω	-	0.2	-	%
α_{AOI}	Audio Output L/R Imbalance ^{1,6}			-	-	0.05	dB
R _{mute}	Mute Attenuation Ratio ¹	Volume[3:0]=	=0000	60	-	-	dB
DW	Audio Response ¹	1KHz=0dB	Low Freq ⁹	-	100	-	U-
BW _{audio}	Audio Response	$\pm 3 \mathrm{dB} \ \mathrm{point}$	High Freq	-	14	-	- Hz
Pins FM_IN, LOUT, ROUT							•
	Pins FM_IN Input Common				0		V
V_{com_rfin}	Mode Voltage						V
V _{com}	Audio Output Common Mode Voltage ⁸			1.0	1.05	1.1	V

Notes:1. F_{in} =65 to 115MHz; F_{mod} =1KHz; de-emphasis=75 μ s; MONO=1; L=R unless noted otherwise;

^{2.} Δf=22.5KHz; 3. $B_{AF} = 300Hz$ to 15KHz, RBW <=10Hz;

^{5.} P_{RF} =60dB_UV; 6. Δf =75KHz,fpilot=10% 8. At LOUT and ROUT pins

^{4.} $|f_2-f_1| > 1MHz$, $f_0=2xf_1-f_2$, AGC disable, $F_{in}=76$ to 108MHz;

^{7.} Measured at V_{EMF} = 1 m V, f $_{\text{RF}}$ = 65 to 108MHz 9. Adjustable

5 Serial Interface

5.1 I²C Interface Timing

Table 5-1 I²C Interface Timing Characteristics

(VDD = 3 V, T_A = 25 °C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
SCLK Frequency	f _{scl}		0	-	400	KHz
SCLK High Time	t _{high}		0.6	-	-	μS
SCLK Low Time	t _{low}		1.3	-	-	μS
Setup Time for START Condition	t _{su:sta}		0.6	-	-	μS
Hold Time for START Condition	t _{hd:sta}		0.6	-	-	μS
Setup Time for STOP Condition	t _{su:sto}		0.6	-	-	μS
SDIO Input to SCLK↑ Setup	t _{su:dat}		100	-	-	ns
SDIO Input to SCLK↓ Hold	t _{hd:dat}		0	-	900	ns
STOP to START Time	t _{buf}		1.3	-	-	μS
SDIO Output Fall Time	t _{f:out}	X	20+0.1C _b	-	250	ns
SDIO Input, SCLK Rise/Fall Time	t _{r:in /} t _{f:in}		20+0.1C _b	-	300	ns
Input Spike Suppression	t _{sp}		/ -	-	50	ns
SCLK, SDIO Capacitive Loading	C _b	A V) Y	-	-	50	pF
Digital Input Pin Capacitance					5	pF

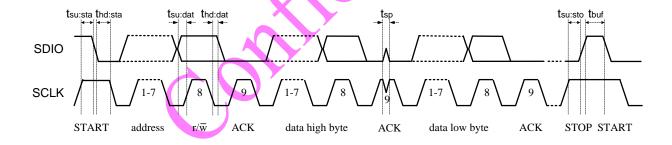


Figure 5-1. I²C Interface Write Timing Diagram

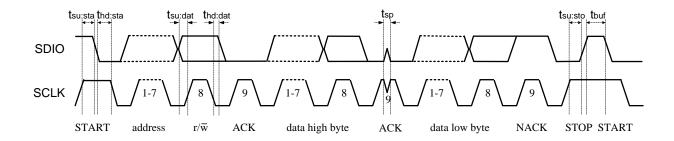


Figure 5-2. I²C Interface Read Timing Diagram

6 Register Definition

REG	BITS	NAME	FUNCTION	DEFAULT
00H	15:8	CHIPID[7:0]	Chip ID.	0x58
02H	15	DHIZ	Audio Output High-Z Disable.	0
			0 = High impedance; 1 = Normal operation	
	14	DMUTE	Mute Disable.	0
			0 = Mute; 1 = Normal operation	
	13	MONO	Mono Select.	0
	40	D.400	0 = Stereo; 1 = Force mono	0
	12	BASS	Bass Boost. 0 = Disabled; 1 = Bass boost enabled	0
	11	RCLK NON-CALIBRATE	0=Bladieu, i = Bass boost enableu 0=RCLK clock is always supply	0
			1=RCLK clock is not always supply when FM	V
		MODE	work (when 1, RDA5807M can't directly	
			support -20 ℃ ~70 ℃ temperature. Only	
			suppory ±20℃ temperature swing from tune	
			point)	
	10	RCLK DIRECT INPUT MODE	1=RCLK clock use the directly input mode	0
	9	SEEKUP	Seek Up.	0
			0 = Seek down; 1 = Seek up	
	8	SEEK	Seek.	0
			0 = Disable stop seek; 1 = Enable	
			Seek begins in the direction specified by	
			SEEKUP and ends when a channel is found, or the entire band has been searched.	
			The SEEK bit is set low and the STC bit is set	
			high when the seek operation completes.	
	7	SKMODE	Seek Mode	0
			0 = wrap at the upper or lower band limit and	
			continue seeking	
			1 = stop seeking at the upper or lower band	
			limit	
	6:4	CLK_MODE[2:0]	000=32.768kHz	000
			001=12Mhz	
			101=24Mhz	
			010=13Mhz	
			110=26Mhz	
			011=19.2Mhz	
			111=38.4Mhz	
	3	RDS_EN	RDS/RBDS enable	<mark>0</mark>
			If 1, rds/rbds enable	
	<mark>2</mark>	NEW_METHOD	New Demodulate Method Enable, can improve	0
			the receive sensitivity about 1dB.	
	1	SOFT_RESET	Soft reset.	0
			If 0, not reset;	
			If 1, reset.	
	İ	<u> </u>	<u> </u>	<u> </u>

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REG	BITS	NAME	FUNCTION	DEFAULT
REO	0	ENABLE	Power Up Enable.	0
	ŭ		0 = Disabled; 1 = Enabled	
03H	15:6	CHAN[9:0]	Channel Select.	0x00
			BAND = 0	
			Frequency =	
			Channel Spacing (kHz) x CHAN+ 87.0 MHz	
			BAND = 1or 2 Frequency =	
			Channel Spacing (kHz) x CHAN + 76.0 MHz	
			BAND = 3	
			Frequency =	
			Channel Spacing (kHz) x CHAN + 65.0 MHz	
			CHAN is updated after a seek operation.	
	5	DIRECT MODE	Directly Control Mode, Only used when test.	0
	4	TUNE	Tune	0
			0 = Disable	
			1 = Enable	
			The tune operation begins when the TUNE bit	
			is set high. The STC bit is set high when the	
			tune operation completes.	
			The tune bit is reset to low automatically when	
			the tune operation completes	
	3:2	BAND[1:0]	Band Select.	00
			00 = 87–108 MHz (US/Europe)	
			01 = 76-91 MHz (Japan)	
			10 = 76–108 MHz (world wide)	
	1:0	SPACE[1:0]	11 = 65 – 76 MHz (East Europe) or 50-65MHz Channel Spacing.	00
	1.0	SPACE[1.0]	00 = 100 kHz	00
			01 = 200 kHz	
			10 = 50kHz	
			11 = 25KHz	
04H	15	RSVD	Reserved	0
	13:12	RSVD	Reserved	00
	11	DE	De-emphasis.	0
			0 = 75 μs; 1 = 50 μs	
	10	RSVD	Reserved	
	9	SOFTMUTE_EN	If 1, softmute enable	1
	8	AFCD	AFC disable.	0
			If 0, afc work;	
			If 1, afc disabled.	
05H	15	INT _MODE	If 0, generate 5ms interrupt;	1
			If 1, interrupt last until read reg0CH action	
			occurs.	

_

 $^{^{1}}$ If $0x07h_bit<9>$ (band)=1, 65-76MHz; =0, 50-76MHz

REG	BITS	NAME	FUNCTION	DEFAULT
	<mark>14:12</mark>	RSVD	Reserved	000
	<mark>11:8</mark>	SEEKTH[3:0] ²	Seek SNR threshold value	<mark>1000</mark>
	<mark>5:4</mark>	RSVD	Resvered	00
	3:0	VOLUME[3:0]	DAC Gain Control Bits (Volume).	<mark>1111</mark>
			0000=min; 1111=max	
			Volume scale is logarithmic	
			When 0000, output mute and output impedance is very large	
06H	15	RSVD	reserved	0
	14:13	OPEN_MODE[1:0]	Open reserved register mode.	00
	1	0. 2.1052[0]	11=open behind registers writing function	00
			others: only open behind registers reading	
			function entered	
07H	15	RSVD	Reserved	0
	<mark>14:10</mark>	TH_SOFRBLEND[5:0]	Threshold for noise soft blend setting, unit 2dB	<mark>10000</mark>
	9	65M_50M MODE	Valid when band[1:0] = 2'b11 (0x03H_bit<3:2>)	1
			1 = 65~76 MHz;	
			0 = 50~76 MHz.	
	8	RSVD	Reserved	0
	7:2	SEEK_TH_OLD3	Seek threshold for old seek mode, Valid when	000000
			Seek_Mode=001	
	1	SOFTBLEND_EN	If 1, Softblend enable	1
	0	FREQ_MODE	If 1, then freq setting changed.	0
			Freq = 76000(or 87000) kHz + freq_direct (08H)	
			kHz.	
0AH	<mark>15</mark>	RDSR	RDS ready	0
			0 = No RDS/RBDS group ready(default)	
			1 = New RDS/RBDS group ready	
	14	STC	Seek/Tune Complete.	0
			0 = Not complete	
			1 = Complete	
			The seek/tune complete flag is set when the	
	13	SF	seek or tune operation completes. Seek Fail.	0
	'3	.	0 = Seek successful; 1 = Seek failure	
			The seek fail flag is set when the seek	
			operation fails to find a channel with an RSSI	
			level greater than SEEKTH[5:0].	
	<mark>12</mark>	RDSS	RDS Synchronization	<mark>0</mark>
			0 = RDS decoder not synchronized(default)	
			1 = RDS decoder synchronized	
			Available only in RDS Verbose mode	
	11	BLK_E	When RDS enable:	0

 $^{^2}$ This value is SNR threshold for seeking, and the default value 1000 is about 32dB SNR. 3 0x20H_bit<14:12>, Seek_Mode register. Default value is 000; When = 001, will add the 5802E seek mode.

REG	BITS	NAME	FUNCTION	DEFAULT
			1 = Block E has been found	
			0 = no Block E has been found	
	10	ST	Stereo Indicator.	1
			0 = Mono; 1 = Stereo	
	9:0	READCHAN[9:0]	Read Channel.	8'h00
			BAND = 0	
			Frequency = Channel Spacing (kHz) x READCHAN[9:0]+ 87.0 MHz	
			BAND = 1 or 2	
			Frequency = Channel Spacing (kHz) x	
			READCHAN[9:0]+ 76.0 MHz	
			BAND = 3 Frequency = Channel Spacing (kHz) x	
			READCHAN[9:0]+ 65.0 MHz	
			READCHAN[9:0] is updated after a tune or	
			seek operation.	_
0BH	15:9	RSSI[6:0]	RSSI.	0
			000000 = min 111111 = max	
			RSSI scale is logarithmic.	
	8	FM TRUE	1 = the current channel is a station	0
			0 = the current channel is not a station	
	7	FM_READY	1=ready	0
			0=not ready	
	<6:5>	reserved		0
	<4>	ABCD_E	1= the block id of register 0cH,0dH,0eH,0fH is E	
			0= the block id of register 0cH, 0dH, 0eH,0fH is	
			A, B, C, D	
	<3:2>	BLERA[1:0]	Block Errors Level of RDS_DATA_0, and is	
			always read as Errors Level of RDS BLOCK A	
			(in RDS mode) or BLOCK E (in RBDS mode	
			when ABCD_E flag is 1)	
			00= 0 errors requiring correction	
			01= 1~2 errors requiring correction	
			10= 3~5 errors requiring correction	
			11= 6+ errors or error in checkword, correction	
			not possible.	
			Available only in RDS Verbose mode	
	<1:0>	BLERB[1:0]	Block Errors Level of RDS_DATA_1, and is	
			always read as Errors Level of RDS BLOCK B	
			(in RDS mode) or E (in RBDS mode when	
			ABCD_E flag is 1).	
			00= 0 errors requiring correction	
			01= 1~2 errors requiring correction	
			10= 3~5 errors requiring correction	
			10- 3-3 errors requiring correction	

REG	BITS	NAME	FUNCTION	DEFAULT
			11= 6+ errors or error in checkword, correction	
			not possible.	
			Available only in RDS Verbose mode	
0CH	<15:0>	RDSA[15:0]	BLOCK A (in RDS mode) or BLOCK E (in	16'h5803
			RBDS mode when ABCD_E flag is 1)	
0DH	<15:0>	RDSB[15:0]	BLOCK B (in RDS mode) or BLOCK E (in	16'h5804
			RBDS mode when ABCD_E flag is 1)	
0EH	<15:0>	RDSC[15:0]	BLOCK C (in RDS mode) or BLOCK E (in	16'h5808
			RBDS mode when ABCD_E flag is 1)	
0FH	<15:0>	RDSD[15:0]	BLOCK D (in RDS mode) or BLOCK E (in	16'h5804
			RBDS mode when ABCD_E flag is 1)	



7 Pins Description

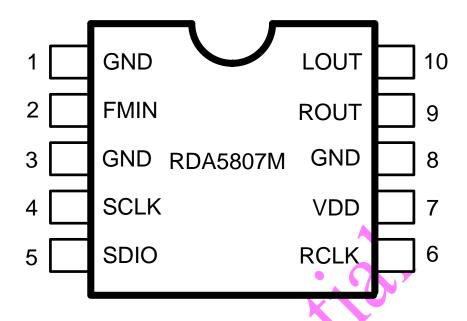


Figure 7-1. RDA5807M Top View

Table 7-1 RDA5807M Pins Description

SYMBOL	PIN	DESCRIPTION
GND	1,3,8	Ground. Connect to ground plane on PCB
FM_IN	2	LNA dual input port.
RCLK	6	32.768KHz crystal oscillator and reference clock input
SDIO	5	Data input/output for serial control bus
SCLK	4	Clock input for serial control bus
VDD	7	Power supply
ROUT,LOUT	9,10	Right/Left audio output

Table 7-2 Internal Pin Configuration

SYMBOL	PIN	DESCRIPTION
FM_IN	2	ENAP MN1 FMs
RCLK	6	VDD
SDIO/SCLK	5/4	SDIO\SCLK Sin Sout

8 Application Diagram

8.1 Audio Loading Resistance Larger than 32 Ω & TCXO Application:

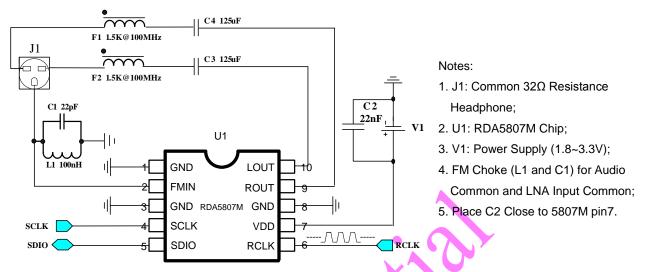


Figure 8-1. RDA5807M FM Tuner Application Diagram (TCXO Application)

8.1.1 Bill of Materials:

COMPONENT	VALUE	DESCRIPTION	SUPPLIER
U1	RDA5807M	Broadcast FM Radio Tuner	RDA
J1		Common 32Ω Resistance Headphone	
L1/C1	100nH/22pF	LC Chock for FM_IN Input	Murata
C3,C4	125µF	Audio AC Couple Capacitors	Murata
C2	22nF	Power Supply Bypass Capacitor	Murata
F1/F2	1.5K@100MHz	FM Band Ferrite	Murata

8.2 Audio Loading Resistance Lower than 32 Ω & DCXO Application:

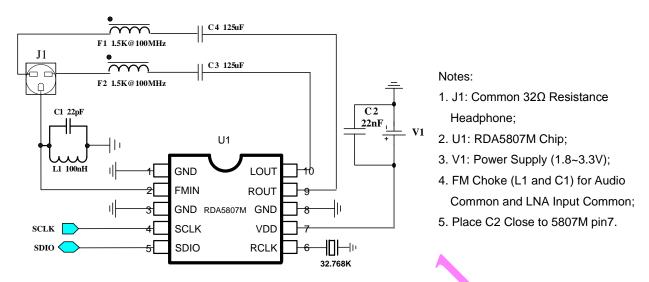


Figure 8-2. RDA5807M FM Tuner Application Diagram (32,768K crystal)

8.2.1 Bill of Materials:

COMPONENT	VALUE	DESCRIPTION	SUPPLIER
U1	RDA5807M	Broadcast FM Radio Tuner	RDA
J1		Common 32Ω Resistance Headphone	
L1/C1	100nH/22pF	LC Chock for FM_IN Input	Murata
C3,C4	125µF	Audio AC Couple Capacitors	Murata
C2	22nF	Power Supply Bypass Capacitor	Murata
F1/F2	1.5K@100MHz	FM Band Ferrite	Murata

9 Physical Dimension

Figure 9-1 illustrates the package details for the RDA5807M. The package is lead-free and RoHS-compliant.

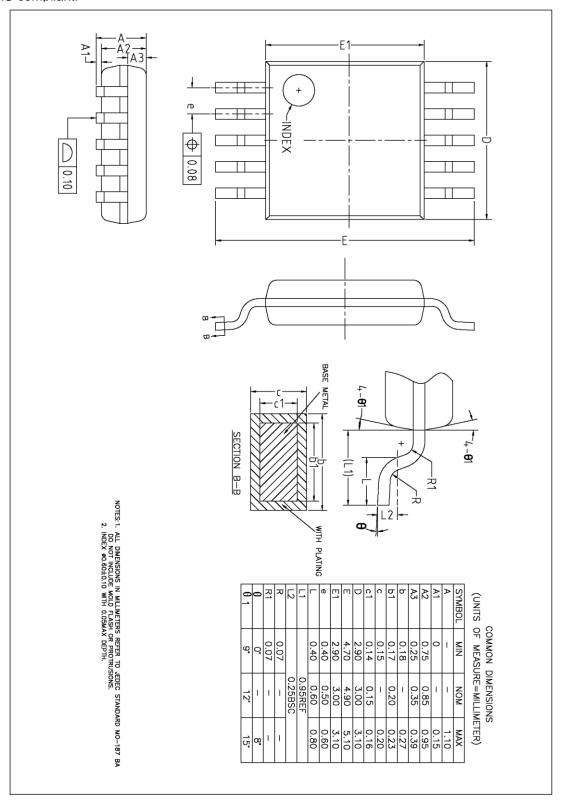


Figure 9-1. 10-Pin MSOP

10 PCB Land Pattern

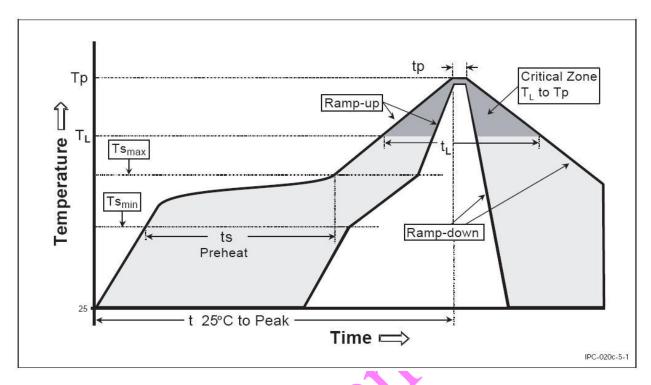


Figure 10-1. Classification Reflow Profile

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp-Up Rate $(T_{Smax} \text{ to } T_p)$	3 °C/second max.	3 °C/second max.
Preheat		
-Temperature Min (T _{smin})	100 °C	150 °C
-Temperature Max (T _{smax})	100 °C	200 °C
-Time (t _{smin} to t _{smax})	60-120 seconds	60-180 seconds
Time maintained above:		
-Temperature (T _L)	183 °C	217°C
-Time (t _L)	60-150seconds	60-150 seconds
Peak /Classification Temperature(T _p)	See Table-II	See Table-III
Time within 5 °C of actual Peak Temperature (t _p)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/seconds max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Table-I Classification Reflow Profiles

Package Thickness	Volume mm³ <350	Volume mm³ ≥350
<2.5mm	240 + 0/-5 ° C	225 + 0/-5 ° C
≥2.5mm	225 + 0/-5 ° C	225 + 0/-5 ° C

Table – II SnPb Eutectic Process – Package Peak Reflow Temperatures

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm³ >2000
<1.6mm	260 + 0 °C *	260 + 0 °C *	260 + 0 °C *
1.6mm – 2.5mm	260 + 0 °C *	250 + 0 °C *	245 + 0 °C *
≥2.5mm	250 + 0 °C *	245 + 0 ° C *	245 + 0 °C *

^{*}Tolerance: The device manufacturer/supplier **shall** assure process compatibility up to and including the stated classification temperature(this mean Peak reflow temperature + 0 °C. For example 260+ 0 °C) at the rated MSL Level.

Table – III Pb-free Process – Package Classification Reflow Temperatures

- **Note 1:** All temperature refer topside of the package. Measured on the package body surface.
- **Note 2:** The profiling tolerance is + 0 ° C, X ° C (based on machine variation capability)whatever
 - is required to control the profile process but at no time will it exceed 5 $^{\circ}$ C. The producer assures process compatibility at the peak reflow profile temperatures defined in Table –III.
- **Note 3:** Package volume excludes external terminals(balls, bumps, lands, leads) and/or non integral heat sinks.
- **Note 4:** The maximum component temperature reached during reflow depends on package the thickness and volume. The use of convection reflow processes reduces the thermal gradients between packages. However, thermal gradients due to differences in thermal mass of SMD package may sill exist.
- **Note 5:** Components intended for use in a "lead-free" assembly process **shall** be evaluated using the "lead free" classification temperatures and profiles defined in Table-I II III whether or not lead free.

RoHS Compliant

The product does not contain lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) or polybrominated diphenyl ethers (PBDE), and are therefore considered RoHS compliant.

ESD Sensitivity

Integrated circuits are ESD sensitive and can be damaged by static electricity. Proper ESD techniques should be used when handling these devices.



Change List

REV	DATE	AUTHER	CHANGE DESCRIPTION
V1.0	2011-05-23	Chun Zhao	Original Draft.

11 Notes:



12 Contact Information

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